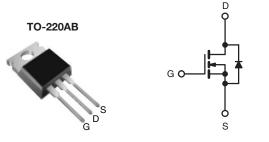


Vishay Siliconix

### Power MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	500			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V 3.0			
Q <sub>g</sub> (Max.) (nC)	24			
Q <sub>gs</sub> (nC)	3.3			
Q <sub>gd</sub> (nC)	13			
Configuration	Single			



N-Channel MOSFET

#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC





#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION		
Package	TO-220AB	
Lead (Pb)-free	IRF820PbF	
Lead (FD)-lifee	SiHF820-E3	
SnPb	IRF820	
SIFD	SiHF820	

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	500	V	
Gate-Source Voltage			$V_{GS}$	± 20	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	L-	2.5	А	
Continuous Drain Current		T <sub>C</sub> = 100 °C	ID	1.6		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	8.0	1	
Linear Derating Factor			0.40	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	210	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	2.5	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	5.0	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			P <sub>D</sub>	50	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	3.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) for 10 s				300 <sup>d</sup>		
Mounting Toyaus	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque				1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 50 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 60 \, \text{mH}$ ,  $R_g = 25 \, \Omega$ ,  $I_{AS} = 2.5 \, \text{A}$  (see fig. 12).
- c.  $I_{SD} \le 2.5$  A,  $dI/dt \le 50$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	2.5		

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	500	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.59	-	V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$		-	-	25 250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 1.5 A <sup>b</sup>	-	-	3.0	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 50 V, I <sub>D</sub> = 1.5 A	1.5	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	360	-	pF
Output Capacitance	Coss		$V_{DS} = 25 \text{ V},$		92	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	0 MHz, see fig. 5	-	37	-	
Total Gate Charge	Qg			-	-	24	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 2.1 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	3.3	nC
Gate-Drain Charge	Q <sub>gd</sub>		See fig. 6 dild 16	-	-	13	
Turn-On Delay Time	t <sub>d(on)</sub>			-	8.0	-	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	250 V, I <sub>D</sub> = 2.1 A,	-	8.6	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 18 \Omega$ ,	$R_D = 100 \Omega$ , see fig. $10^b$	-	33	-	ns
Fall Time	t <sub>f</sub>	- 16		16	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact  - 4.5 - 7.5 -		-	4.5	-	الم
Internal Source Inductance	L <sub>S</sub>			-	→ nH		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	showing the integral reverse		-	-	2.5	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			8.0			
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 2.5 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	1.6	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05.00 !	0.4.0 41/4± 400.07 -	-	260	520	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$J_{\rm J} = 25  {\rm ^{5}C}, I_{\rm J}$	<sub>F</sub> = 2.1 A, dl/dt = 100 A/μs	-	0.7	1.4	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	y L <sub>S</sub> and	L <sub>D</sub> )

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

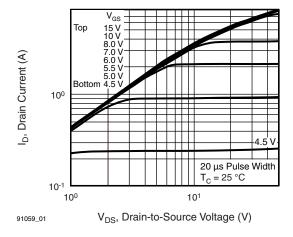


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

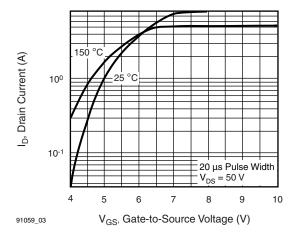


Fig. 3 - Typical Transfer Characteristics

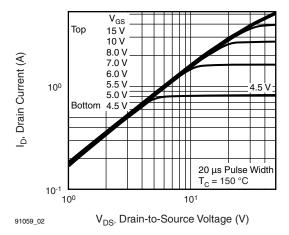


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

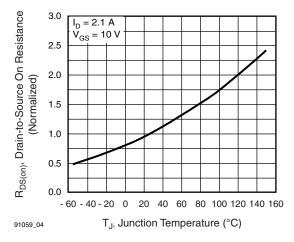


Fig. 4 - Normalized On-Resistance vs. Temperature

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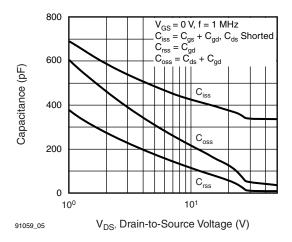


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

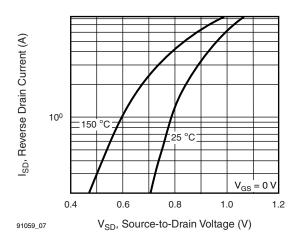


Fig. 7 - Typical Source-Drain Diode Forward Voltage

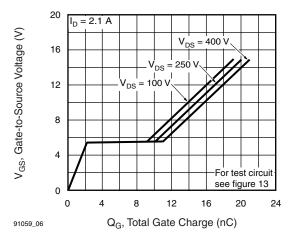


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

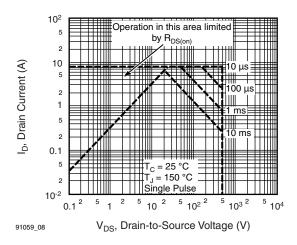


Fig. 8 - Maximum Safe Operating Area





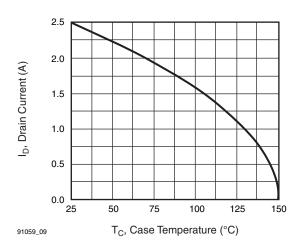


Fig. 9 - Maximum Drain Current vs. Case Temperature

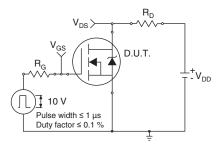


Fig. 10a - Switching Time Test Circuit

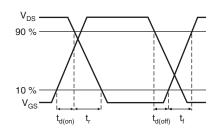


Fig. 10b - Switching Time Waveforms

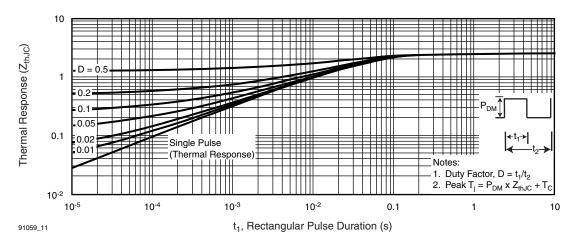


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

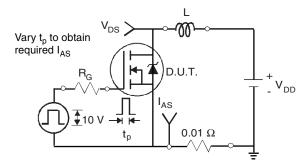


Fig. 12a - Unclamped Inductive Test Circuit

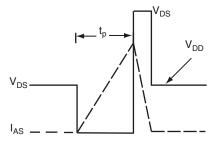


Fig. 12b - Unclamped Inductive Waveforms



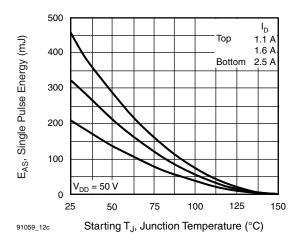


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

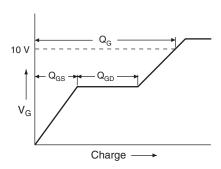


Fig. 13a - Basic Gate Charge Waveform

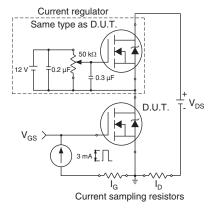
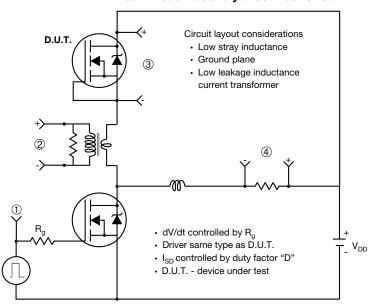


Fig. 13b - Gate Charge Test



#### Peak Diode Recovery dV/dt Test Circuit



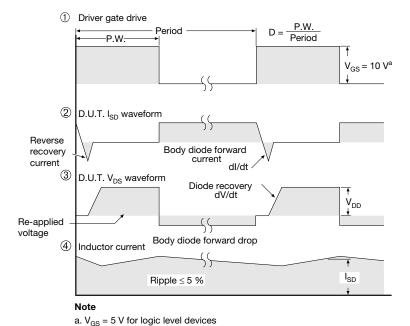


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91059.





## TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

#### Note

 $\bullet$   $M^{\star}=0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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